

NB6L72

2.5V / 3.3V Differential 2 X 2 Crosspoint Switch with LVPECL Outputs

Multi-Level Inputs w/ Internal Termination

Description

The NB6L72 is a clock or data high-bandwidth fully differential 2 x 2 Crosspoint Switch with internal source termination and LVPECL output structure, optimized for low skew and minimal jitter. The differential inputs incorporate internal 50 Ω termination resistors and will accept LVPECL, CML, LVDS, LVCMOS, or LVTTTL logic levels. The SELECT inputs are single-ended and can be driven with LVCMOS/LVTTTL.

The differential LVPECL outputs provide 800 mV output swings when externally terminated with a 50 Ω resistor to $V_{CC} - 2.0$ V.

The device is offered in a small 3 mm x 3 mm 16-pin QFN package.

The NB6L72 is a member of the ECLinPS MAX™ family of high performance clock and data management products.

Features

- Input Clock Frequency > 3.0GHz
- Input Data Rate > 3 Gb/s
- 425 ps Typical Propagation Delay
- 100 ps Typical Rise and Fall Times
- 0.5 ps maximum RMS Clock Jitter
- LVPECL, CML or LVDS Input Compatible
- Differential LVPECL Outputs, 800 mV Amplitude, Typical
- Operating Range: $V_{CC} = 2.375$ V to 3.63 V with GND = 0 V
- Internal 50 Ω Input Termination Provided
- Functionally Compatible with Existing 2.5 V/3.3 V LVEL, LVEP, EP, and SG Devices
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices



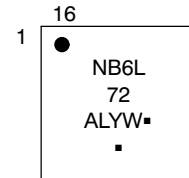
ON Semiconductor®

<http://onsemi.com>

MARKING DIAGRAM*



QFN-16
MN SUFFIX
CASE 485G



A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package
(Note: Microdot may be in either location)

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

NB6L72

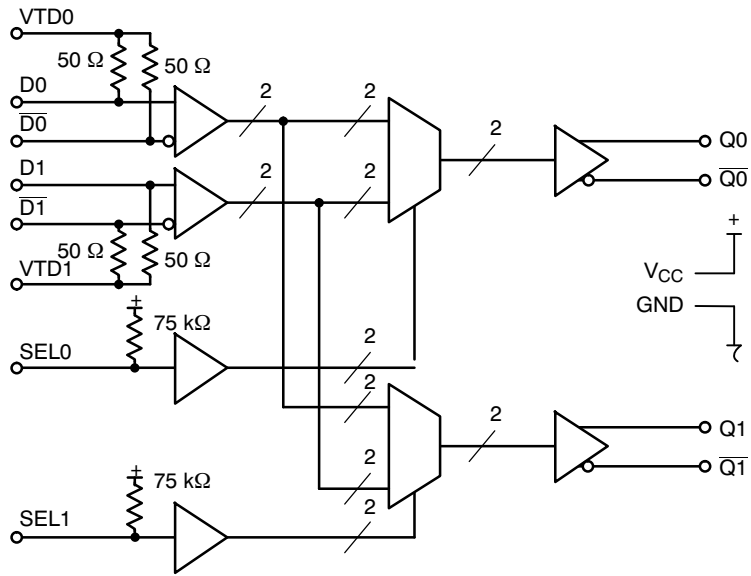


Figure 1. Logic/Block Diagram

NB6L72

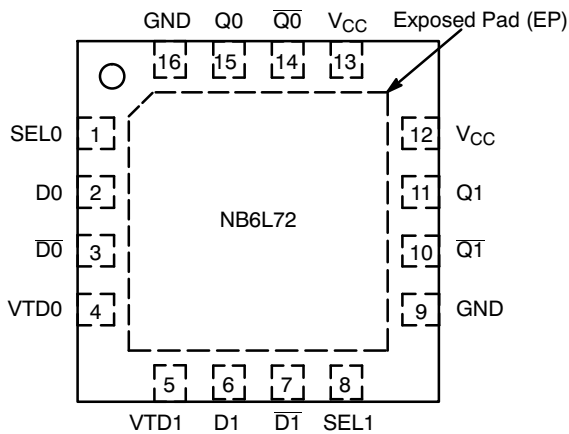


Figure 2. Pin Configuration (Top View)

Table 1. INPUT/OUTPUT SELECT TRUTH TABLE

| SEL0* | SEL1* | Q0 | Q1 |
|-------|-------|----|----|
| L | L | D0 | D0 |
| H | L | D1 | D0 |
| L | H | D0 | D1 |
| H | H | D1 | D1 |

*Defaults HIGH when left open

Table 2. PIN DESCRIPTION

| Pin | Name | I/O | Description |
|-----|-----------------|--|--|
| 1 | SEL0 | LVTTTL, LVCMOS Input | Select Logic Input control that selects D0 or D1 to output Q0. See Table 1, Select Input Function Table. Pin defaults HIGH when left open |
| 2 | D0 | LVPECL, CML, LVDS, LVTTTL, LVCMOS, Input | Noninverted Differential Input. Note 1. |
| 3 | D0 | LVPECL, CML, LVDS, LVTTTL, LVCMOS, Input | Inverted Differential Input. Note 1. |
| 4 | VTD0 | - | Internal 50 Ω Termination Pin. Note 1. |
| 5 | VTD1 | - | Internal 50 Ω termination pin. Note 1. |
| 6 | D1 | LVPECL, CML, LVDS, LVTTTL, LVCMOS, Input | Noninverted Differential Input. Note 1. |
| 7 | D1 | LVPECL, CML, LVDS, LVTTTL, LVCMOS, Input | Inverted Differential Input. Note 1. |
| 8 | SEL1 | LVTTTL, LVCMOS Input | Select Logic Input control that selects D0 or D1 to output Q1. See Table 1, Select Input Function Table. Pin defaults HIGH when left open |
| 9 | GND | - | Negative Supply Voltage |
| 10 | Q1 | LVPECL Output | Inverted Differential Output. Typically Terminated with 50 Ω Resistor to V _{CC} - 2.0 V. |
| 11 | Q1 | LVPECL Output | Noninverted Differential Output. Typically Terminated with 50 Ω Resistor to V _{CC} - 2.0 V. |
| 12 | V _{CC} | - | Positive Supply Voltage |
| 13 | V _{CC} | - | Positive Supply Voltage |
| 14 | Q0 | LVPECL Output | Inverted Differential Reset Input. Typically Terminated with 50 Ω Resistor to V _{CC} - 2.0 V. |
| 15 | Q0 | LVPECL Output | Noninverted Differential Reset Input. Typically Terminated with 50 Ω Resistor to V _{CC} - 2.0 V. |
| 16 | GND | - | Negative Supply Voltage |
| - | EP | - | The Exposed Pad (EP) on the QFN-16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is not electrically connected to the die, but is recommended to be electrically and thermally connected to GND on the PC board. |

1. In the differential configuration when the input termination pin (VTD_n, VTD_n) are connected to a common termination voltage or left open, and if no signal is applied on D_n/D_n input, then the device will be susceptible to self-oscillation.
2. All V_{CC} and GND pins must be externally connected to a power supply for proper operation.

NB6L72

Table 3. ATTRIBUTES

| Characteristics | Value |
|--|----------------------|
| ESD Protection Human Body Model Machine Model | > 2 kV > 200 V |
| Moisture Sensitivity 16-QFN | Level 1 |
| Flammability Rating Oxygen Index: 28 to 34 | UL 94 V-0 @ 0.125 in |
| Transistor Count | |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test | |

For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

| Symbol | Parameter | Condition 1 | Condition 2 | Rating | Unit |
|-------------------|---|---------------------|--------------------------------------|-----------------------|--------------|
| V _{CC} | Positive Power Supply | GND = 0 V | | 4.0 | V |
| V _{IO} | Positive Input/Output Voltage | GND = 0 V | $-0.5 \leq V_{IO} \leq V_{CC} + 0.5$ | 4.5 | V |
| V _{INPP} | Differential Input Voltage D - \bar{D} | | | V _{CC} - GND | V |
| I _{IN} | Input Current Through R _T (50 Ω Resistor) | Static Surge | | 45 80 | mA mA |
| I _{OUT} | Output Current (LVPECL Output) | Continuous Surge | | 50 100 | mA mA |
| T _A | Operating Temperature Range | QFN-16 | | -40 to +85 | °C |
| T _{stg} | Storage Temperature Range | | | -65 to +150 | °C |
| θ_{JA} | Thermal Resistance (Junction-to-Ambient) (Note 3) | 0 lfpm 500 lfpm | QFN-16 QFN-16 | 42 35 | °C/W °C/W |
| θ_{JC} | Thermal Resistance (Junction-to-Case) | (Note 3) | QFN-16 | 4 | °C/W |
| T _{sol} | Wave Solder Pb-Free | | | 265 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

3. JEDEC standard multilayer board - 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

NB6L72

Table 5. DC CHARACTERISTICS, Multi-Level Inputs $V_{CC} = 2.375\text{ V to }3.63\text{ V}$, $GND = 0\text{ V}$, $T_A = -40^\circ\text{C to }+85^\circ\text{C}$

| Symbol | Characteristic | Min | Typ | Max | Unit |
|--------|----------------|-----|-----|-----|------|
|--------|----------------|-----|-----|-----|------|

POWER SUPPLY CURRENT

| | | | | | |
|----------|--|----|----|----|----|
| I_{CC} | Power Supply Current (Inputs and Outputs Open) | 40 | 60 | 80 | mA |
|----------|--|----|----|----|----|

LVPECL OUTPUTS (Notes 4 and 5)

| | | | | | |
|----------|---|---------------------------------|--------------------------------|--------------------------------|----|
| V_{OH} | Output HIGH Voltage $V_{CC} = 3.3\text{ V}$ $V_{CC} = 2.5\text{ V}$ | $V_{CC} - 1075$ 2225 1425 | $V_{CC} - 950$ 2350 1550 | $V_{CC} - 825$ 2475 1675 | mV |
| V_{OL} | Output LOW Voltage $V_{CC} = 3.3\text{ V}$ $V_{CC} = 2.5\text{ V}$ | $V_{CC} - 1825$ 1475 675 | $V_{CC} - 1725$ 1575 775 | $V_{CC} - 1625$ 1675 875 | mV |

DIFFERENTIAL INPUT DRIVEN SINGLE-ENDED (see Figures 4 and 5) (Note 6)

| | | | | | |
|-----------|--|----------------|--|----------------|----|
| V_{th} | Input Threshold Reference Voltage Range (Note 7) | 1125 | | $V_{CC} - 150$ | mV |
| V_{IH} | Single-ended Input HIGH Voltage | $V_{th} + 150$ | | V_{CC} | mV |
| V_{IL} | Single-ended Input LOW Voltage | GND | | $V_{th} - 150$ | mV |
| V_{ISE} | Single-ended Input Voltage Amplitude ($V_{IH} - V_{IL}$) | 300 | | $V_{CC} - GND$ | mV |

DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY (see Figures 7 and 9)

| | | | | | |
|-----------|--|------|--|----------------|---------------|
| V_{IHD} | Differential Input HIGH Voltage | 1050 | | V_{CC} | mV |
| V_{ILD} | Differential Input LOW Voltage | GND | | $V_{CC} - 150$ | mV |
| V_{ID} | Differential Input Voltage ($D_n, \overline{D_n}$) ($V_{IHD} - V_{ILD}$) | 150 | | $V_{CC} - GND$ | mV |
| V_{CMR} | Input Common Mode Range (Differential Configuration) (Note 9) | 950 | | $V_{CC} - 75$ | mV |
| I_{IH} | Input HIGH Current $D_n/\overline{D_n}$, ($V_{TDn}/\overline{V_{TDn}}$ Open) | -150 | | +150 | μA |
| I_{IL} | Input LOW Current $D_n/\overline{D_n}$, ($V_{TDn}/\overline{V_{TDn}}$ Open) | -150 | | +150 | μA |

SINGLE-ENDED LVCMOS/LVTTL CONTROL INPUTS

| | | | | | |
|----------|---------------------------------|------|--|----------|---------------|
| V_{IH} | Single-ended Input HIGH Voltage | 2000 | | V_{CC} | mV |
| V_{IL} | Single-ended Input LOW Voltage | GND | | 800 | mV |
| I_{IH} | Input HIGH Current | -10 | | 10 | μA |
| I_{IL} | Input LOW Current | -150 | | 0 | μA |

TERMINATION RESISTORS

| | | | | | |
|-----------|-------------------------------------|----|----|----|----------|
| R_{TIN} | Internal Input Termination Resistor | 40 | 50 | 60 | Ω |
|-----------|-------------------------------------|----|----|----|----------|

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

4. LVPECL outputs loaded with $50\ \Omega$ to $V_{CC} - 2.0\text{ V}$ for proper operation.
5. Input and output parameters vary 1:1 with V_{CC} .
6. V_{th} , V_{IH} , V_{IL} , and V_{ISE} parameters must be complied with simultaneously.
7. V_{th} is applied to the complementary input when operating in single-ended mode.
8. V_{IHD} , V_{ILD} , V_{ID} and V_{CMR} parameters must be complied with simultaneously.
9. V_{CMR} minimum varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC} . The V_{CMR} range is referenced to the most positive side of the differential input signal.

NB6L72

Table 6. AC CHARACTERISTICS $V_{CC} = 2.375\text{ V to }3.63\text{ V}$, $V_{EE} = 0\text{ V}$, or $V_{CC} = 0\text{ V}$, $V_{EE} = -2.375\text{ V to }-3.63\text{ V}$,
 $T_A = -40^\circ\text{C to }+85^\circ\text{C}$; (Note 10)

| Symbol | Characteristic | Min | Typ | Max | Unit | |
|--------------------------|--|--|-------------------|------------------------|----------------|----|
| V_{OUTPP} | Output Voltage Amplitude (@ $V_{INPPmin}$) (Note 14) (See Figure 16) | $f_{in} \leq 1.5\text{ GHz}$ $f_{in} \leq 2.5\text{ GHz}$ $f_{in} \leq 3.0\text{ GHz}$ | 520 380 320 | 800 650 500 | | mV |
| t_{PLH} , t_{PHL} | Propagation Delay (@0.5GHz) | Dn to Qn SELn to Qn | 325 | 425 | 525 | ps |
| t_{SKEW} | Duty Cycle Skew (Note 11) Within Device Skew Device to Device Skew (Note 12) | | 5 | 20 20 80 | | ps |
| t_{DC} | Output Clock Duty Cycle (Reference Duty Cycle = 50%) | $f_{in} \leq 3.0\text{ GHz}$ | 40 | 50 | 60 | % |
| t_{JITTER} | RMS Random Clock Jitter (Note 13) Data Dependent Jitter | $f_{in} = 2.5\text{ GHz}$ $f_{in} = 3.0\text{ GHz}$ $f_{DATA} = 2.5\text{ Gb/s}$ $f_{DATA} = 3.0\text{ Gb/s}$ | | 0.2 0.3 12 15 | 0.5 1 | ps |
| V_{INPP} | Input Voltage Swing/Sensitivity (Differential Configuration) (Note 14) | | 150 | | $V_{CC} - GND$ | mV |
| t_r, t_f | Output Rise/Fall Times @ 0.5 GHz (20% – 80%) | Q, \bar{Q} | | 100 | 160 | ps |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

10. Measured by forcing V_{INPP} (minimum) from a 50% duty cycle clock source. All loading with an external $R_L = 50\ \Omega$ to $V_{CC} - 2.0\text{ V}$. Input edge rates 40 ps (20% – 80%).

11. Duty cycle skew is measured between differential outputs using the deviations of the sum of T_{pw-} and T_{pw+} @ 0.5 GHz.

12. Device to device skew is measured between outputs under identical transition @ 0.5 GHz.

13. Additive RMS jitter with 50% duty cycle clock signal.

14. Input and output voltage swing is a single-ended measurement operating in differential mode.

NB6L72

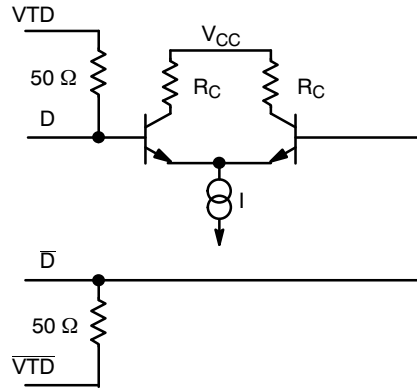


Figure 3. Input Structure

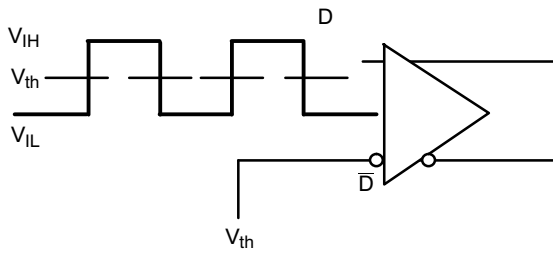


Figure 4. Differential Input Driven Single-Ended

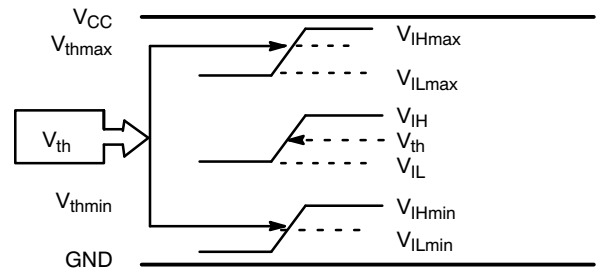


Figure 5. V_{th} Diagram

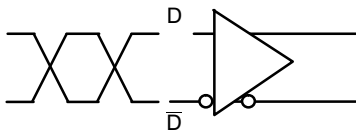


Figure 6. Differential Inputs Driven Differentially

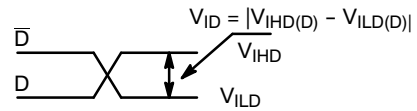


Figure 7. Differential Inputs Driven Differentially

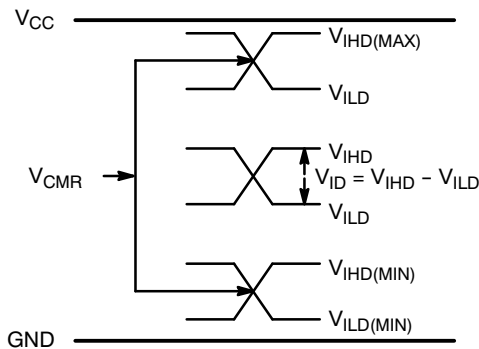


Figure 8. V_{CMR} Diagram

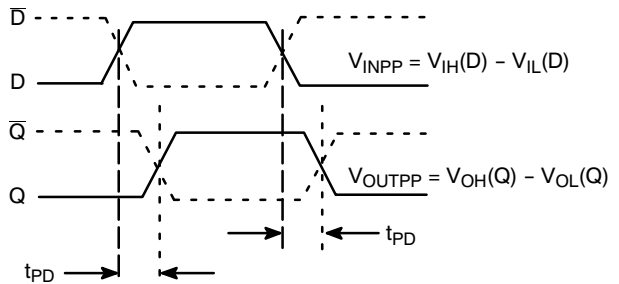


Figure 9. AC Reference Measurement

NB6L72

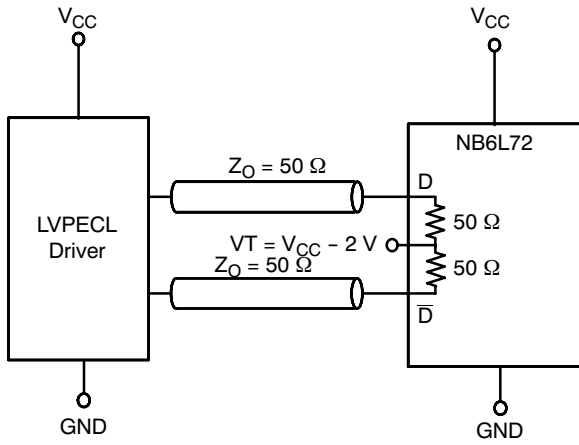


Figure 10. LVPECL Interface

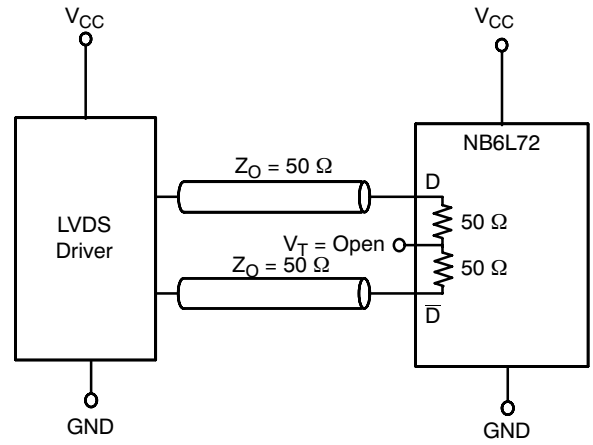


Figure 11. LVDS Interface

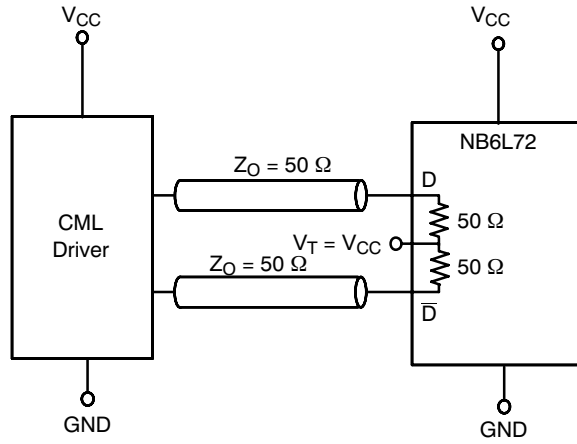


Figure 12. Standard 50 Ω Load CML Interface

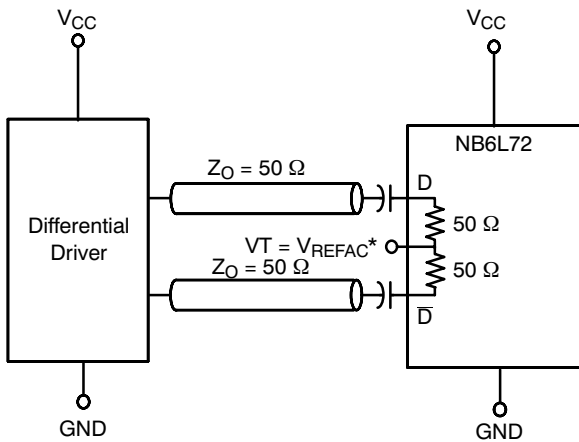


Figure 13. Capacitor-Coupled Differential Interface (VT Connected to V_{REFAC})

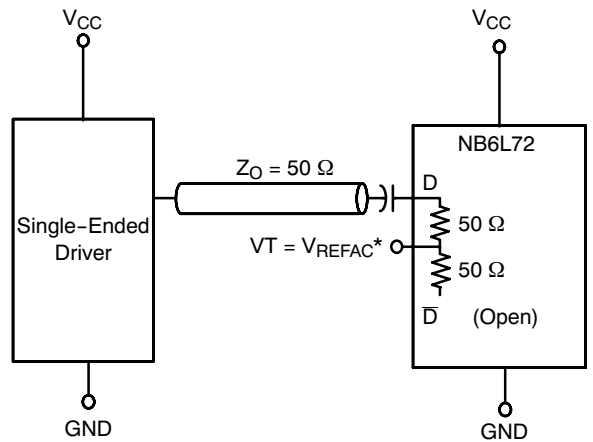


Figure 14. Capacitor-Coupled Single-Ended Interface (VT Connected to V_{REFAC})

* V_{REFAC} bypassed to ground with a 0.01 μ F capacitor

NB6L72

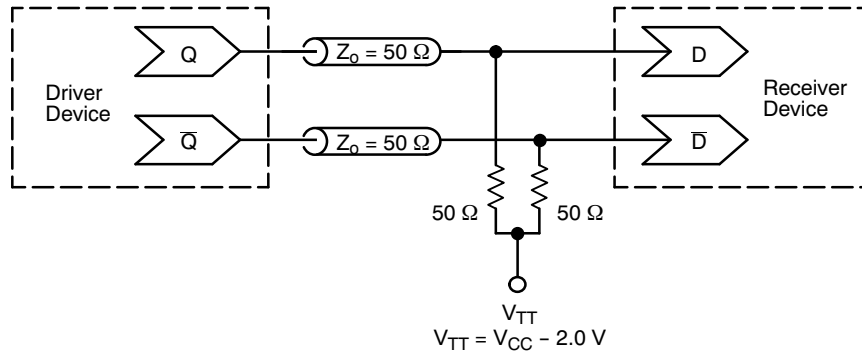


Figure 15. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

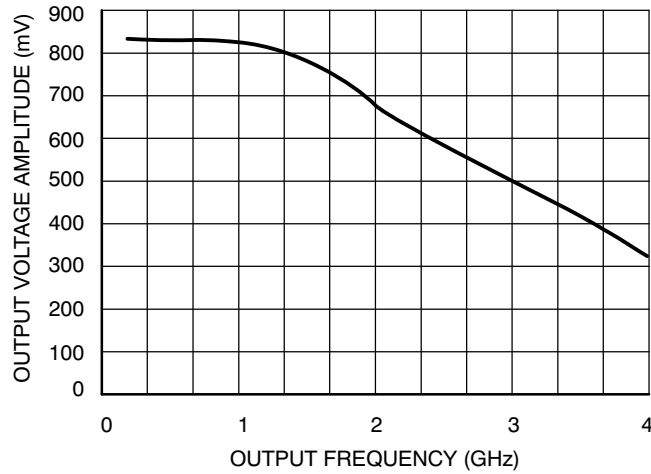


Figure 16. Output Voltage Amplitude (V_{OUTPP}) versus Output Frequency at Ambient Temperature (Typical)

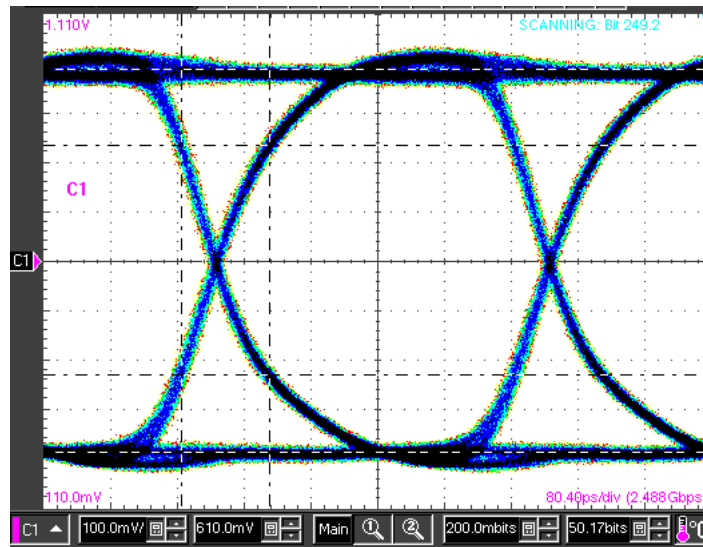
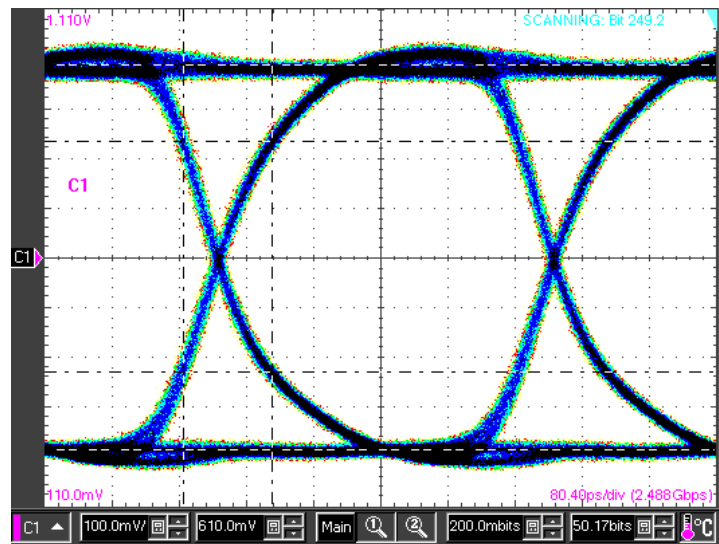


Figure 17. Typical Output Wave Form – Data Signal PRBS $2^{23}-1$ Room Temperature, 400 mV Input Amplitude, $V_{CC} = 2.5\text{ V}$, 2.488 Gb/s (X-scale = 80 ps/DIV; y-Scale = 100 mV/DIV)

NB6L72



Total Jitter = 28 ps
 Device Jitter = 15 ps
 Input Jitter = 13 ps

Figure 18. Typical Output Wave Form – Data Signal PRBS $2^{23}-1$ Room Temperature, 75 mV Input Amplitude, 3 Gb/s (X-scale = 80 ps/DIV; y-Scale = 100 mV/DIV)

ORDERING INFORMATION

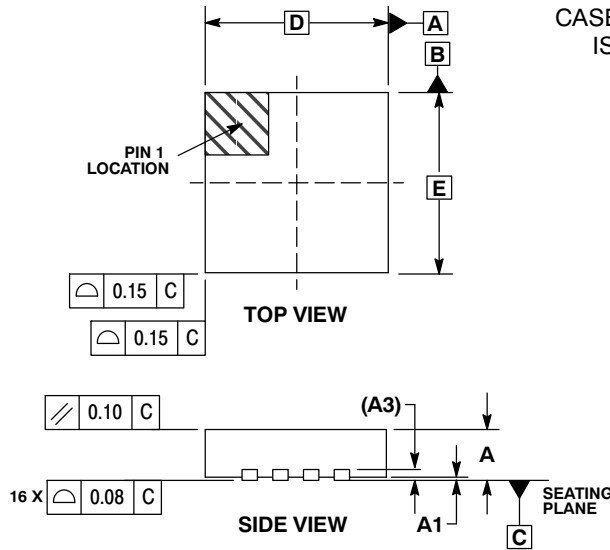
| Device | Package | Shipping [†] |
|-------------|---------------------|-----------------------|
| NB6L72MNG | QFN-16 (Pb-free) | 123 Units / Rail |
| NB6L72MNR2G | QFN-16 (Pb-free) | 3000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NB6L72

PACKAGE DIMENSIONS

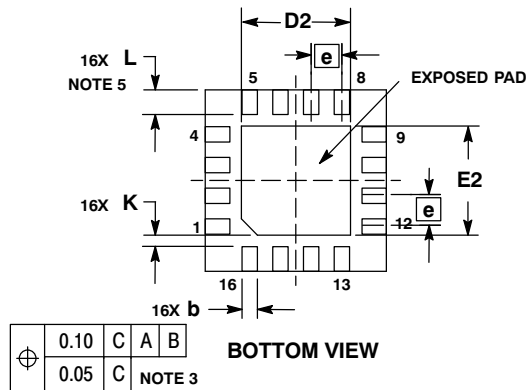
16 PIN QFN
MN SUFFIX
CASE 485G-01
ISSUE C



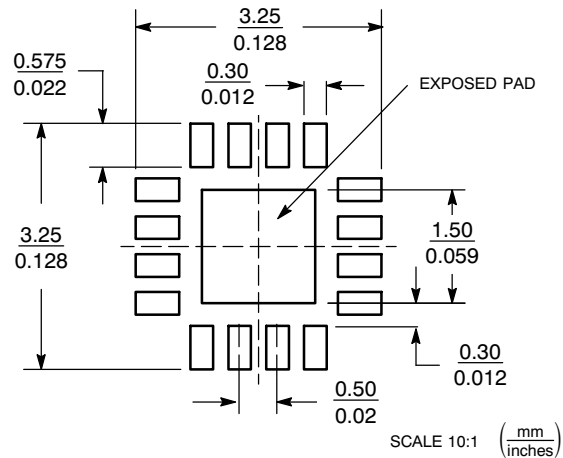
NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. L_{max} CONDITION CAN NOT VIOLATE 0.2 MM MINIMUM SPACING BETWEEN LEAD TIP AND FLAG

| MILLIMETERS | | |
|-------------|------|------|
| DIM | MIN | MAX |
| A | 0.80 | 1.00 |
| A1 | 0.00 | 0.05 |
| A3 | 0.20 | REF |
| b | 0.18 | 0.30 |
| D | 3.00 | BSC |
| D2 | 1.65 | 1.85 |
| E | 3.00 | BSC |
| E2 | 1.65 | 1.85 |
| e | 0.50 | BSC |
| K | 0.18 | TYP |
| L | 0.30 | 0.50 |



SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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